



国家开发银行  
CHINA DEVELOPMENT BANK

CHINA DEVELOPMENT BANK  
BENCHMARK BOND ISSUANCE PROGRAMME  
TENDER ANNOUNCEMENT

11 June 2021

|                            |   |
|----------------------------|---|
| Issue Number               | 210207                                      |
| Tender Type                | New Issue                                   |
| Tender Date                | 15 June 2021                                |
| Tender Time                | 9:30 to 10:30                               |
| Offering Amount            | Renminbi 5 Billion                          |
| Interest Type              | Fixed                                       |
| Coupon Rate                | Determined at Auction                       |
| Interest Payment Frequency | Annually                                    |
| Interest Payment Date      | 17 June                                     |
| Original Tenor             | Three Years                                 |
| Maturity Date              | 17 June 2024                                |
| Issue and Settlement Date  | 17 June 2021                                |
| Dated Date(Value Date)     | 17 June 2021                                |
| Listing Date               | 21 June 2021                                |
| Clearing House             | China Central Depository & Clearing Co.,Ltd |
| Market                     | China's Inter-bank Bond Market(CIBM)        |
| Rating                     | Exempted for issuance in CIBM               |

For offshore issuance,China's Quasi-sovereign ratings, i.e. Moody's: A1(Stable),S&P: A+(Stable)

\*Disclaimer

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CDB's bond yield curve available at <http://www.cdb.com.cn>.